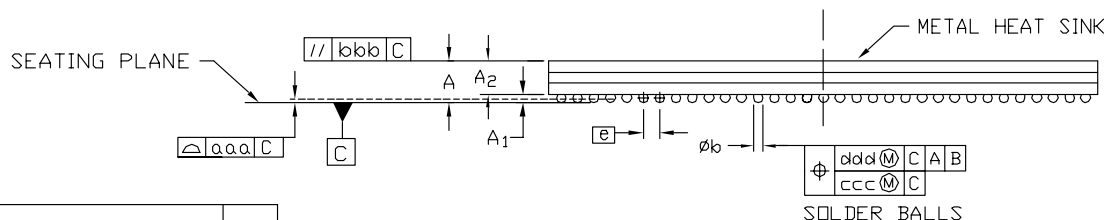
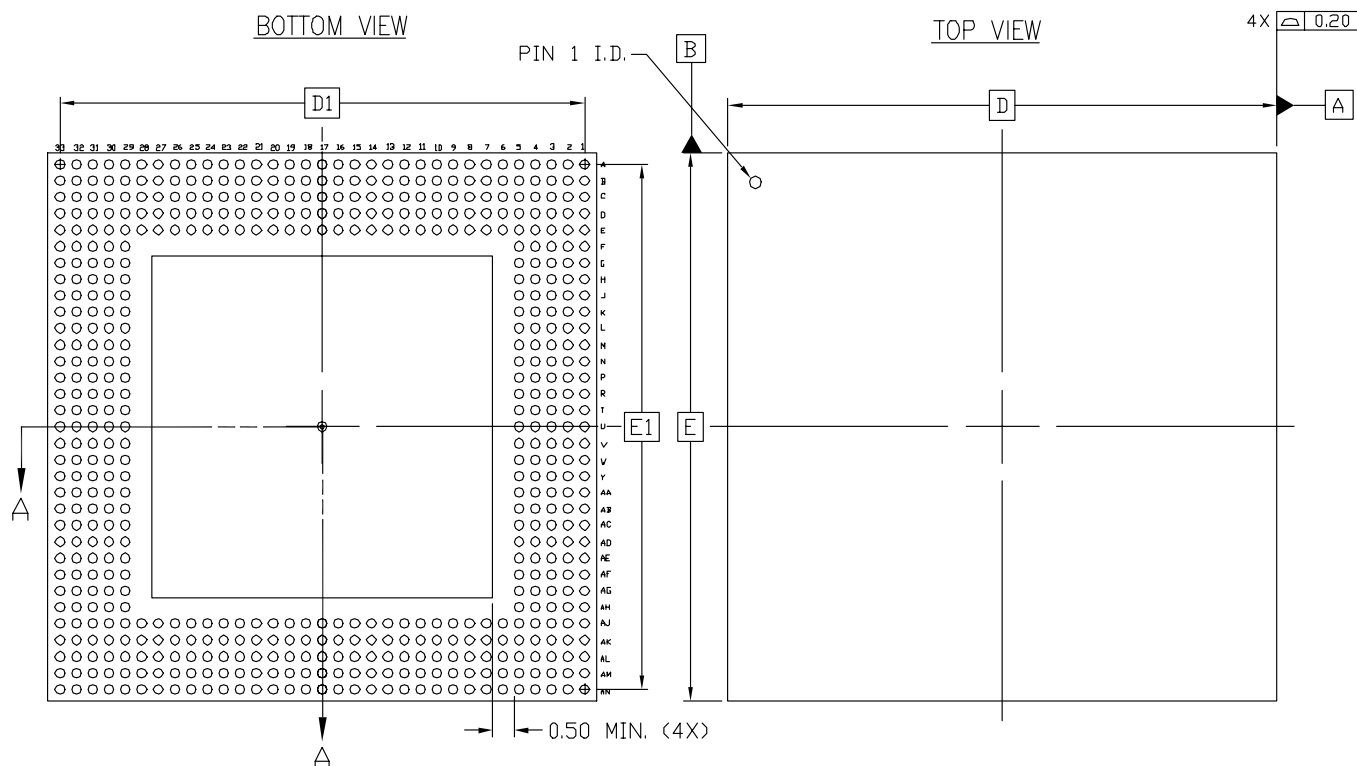
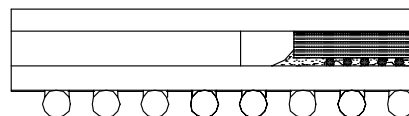


BF560: Plastic Flip-Chip BGA Package



SYMBOL	MILLIMETERS			NOTE
	MIN.	NOM.	MAX.	
A	xx	xx	3.30	2
A ₁	0.50	0.60	0.70	
A ₂	xx	xx	2.60	
A ₃	0.20	xx	xx	
D/E	42.50 BSC			
D ₁ /E ₁	40.64 REF.			
e	1.27 BSC			
øb	0.60	0.75	0.90	
aaa	xx	xx	0.20	
bbb	xx	xx	0.25	
ccc	xx	xx	0.15	
ddd	xx	xx	0.30	
M	33			



SECTION A-A
(NOT TO SCALE)

NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1994
2. SYMBOL 'M' IS THE PIN MATRIX SIZE.
3. CONFORMS TO JEDEC MS-034-BAV-1 (DEPOPULATED)